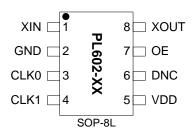


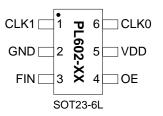
HCSL Compatible Clock Generator for PCI Express PIN CONFIGURATION

• Input Frequency:

FEATURES

- o Fundamental Crystal or Reference Input: 25MHz
- Output Frequency:
 - o PL602-21: 100MHz differential outputs.
 - o PL602-22: 125MHz differential outputs.
 - o PL602-23: 200MHz differential outputs.
 - PL602-26: 25MHz differential outputs.
 - o PL602-27: 250MHz differential outputs.
 - o PL602-15: 156.25 MHz differential outputs.
- Very low Jitter: 28ps Pk-Pk typ.
- Very low Phase Noise:
 - o -130 dBc at 10kHz offset at 100MHz
- No external loop filter is required
- Power supply range: 2.25V to 3.63V
- Operating temperature range from -40°C to 85°C
- Available in 6-pin SOT or 8-pin SOP Green/RoHS compliant package.

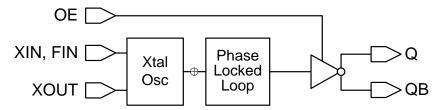




DESCRIPTION

The PL602-XX is the smallest, high performance, lowest power differential output clock IC available for HCSL timing applications. PL602-XX offers -130dBc at 10kHz offset at 100MHz, with a very low jitter (2 ps TIE RMS), making it ideal for HCSL applications requiring small size and low power.

BLOCK DIAGRAM



PIN DESCRIPTION

Nome	Pin #		T	Description	
Name	SOP	SOT23	Type		
XIN	1	-	I	Crystal input (SOP package only)	
FIN	-	3	I	Reference clock input (SOT23 package only)	
GND	2	2	Р	GND connection	
CLK[0:1]	3,4	1,6	0	Differential clock outputs [note:CLK0=~CLK1]	
VDD	5	5	Р	VDD connection	
DNC	6	-	-	Do not connect	
OE	7	4	I	Output enable (OE) input. Internal 60KΩ pull up resistor.	
XOUT	8	-	0	Crystal output pin.	



ELECTRICAL SPECIFICATIONS ABSOLUTE MAXIMUM RATINGS

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage Range	V_{DD}	-0.5	4.6	٧
Input Voltage Range	Vı	-0.5	V _{DD} +0.5	٧
Output Voltage Range	Vo	-0.5	V _{DD} +0.5	٧
Soldering Temperature			260	°C
Storage Temperature	Ts	-65	150	°C
Ambient Operating Temperature*		-40	+85	°C

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied. *Operating temperature is guaranteed by design. Parts are tested to commercial grade only.

AC SPECIFICATIONS

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Crystal Input Frequency	Fundamental Crystal		25		MHz
Input (F _{IN}) Frequency			25		MHz
Input (F _{IN}) Signal Amplitude	Internally AC coupled	0.9		V_{DD}	Vpp
Output Frequency		25		200	MHz
Output Enable Time	OE Function; Ta=25° C, Add one clock period to this measurement for a usable clock output.			10	ns
Output Disable Time	OE Function; Ta=25° C			10	ns
Settling Time	At power-up $(V_{DD} \ge 2.25V)$			10	ms
VDD Sensitivity	Frequency vs. V _{DD} , ±10%	-2		2	ppm
Output Rise Time	10/90%V _{он}		0.3	0.5	ns
Output Fall Time	90/10%V _{он}		0.3	0.5	ns
Skew Between Outputs	Measured at 50% V _{OH}			250	ps
Duty Cycle	At V _{DD} /2	45	50	55	%
Period Jitter, peak-to-peak	With canacitive decoupling between V		28		ps
Cycle-to-Cycle, RMS	- With capacitive decoupling between V_{DD} and GND		9		ps
Cycle-to-Cycle, peak	- At 100MHz		25		ps
TIE, RMS	- 20,000 samples measured		2		ps



DC SPECIFICATIONS

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Current, Dynamic	I _{DD}	At 100MHz, No Load		25		mA
Operating Voltage	V_{DD}		2.25		3.63	V
Output Low Voltage	V _{OL}	HCSL termination,			0.05	V
Output High Voltage	V _{OH}	$(RS = 150\Omega, RT = 49.9\Omega) 3.3V$	0.65	0.75	0.85	V
Output Current	I _{OSD}	$(RS = 100\Omega, RT = 49.9\Omega) 2.5V$	13	15	17	mA

CRYSTAL SPECIFICATIONS

PARAMETERS	SYMBOL	MIN.	TYP.	MAX.	UNITS
Fundamental Crystal Resonator Frequency	F _{XIN}		25		MHz
Crystal Loading Rating	C _{L (xtal)}		18		pF
Maximum Sustainable Drive Level				500	μW
Operating Drive Level			100		μW
Crystal Shunt Capacitance	C0			6	pF
Effective Series Resistance, Fundamental	ESR			45	Ω



PCI EXPRESS/HCSL COMPATIBLE LAYOUT GUIDELINES

Figure 1 below describes how to terminate the complementary LVCMOS outputs of PL602-XX for use with HCSL inputs.

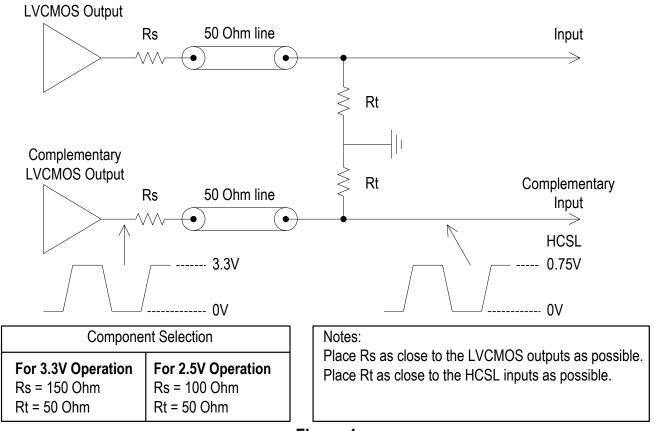


Figure 1

PCB LAYOUT CONSIDERATIONS FOR PERFORMANCE OPTIMIZATION

The following guidelines are to assist you with a performance optimized PCB design:

- Keep all the PCB traces to PL602-XX as short as possible, as well as keeping all other traces as far away from it as possible.
- Place the crystal as close as possible to both crystal pins of the device. This will reduce the cross-talk between the crystal and the other signals.
- Separate crystal pin traces from the other signals on the PCB, but allow ample distance between the two crystal pin traces.
- Place a 0.01µF~0.1µF decoupling capacitor between VDD and GND, on the component side of the PCB, close to the VDD pin. It is not recommended to place this component on the backside of the PCB.

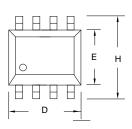
- It is highly recommended to keep the VDD and GND traces as short as possible.
- When connecting long traces (> 1 inch) to a CMOS output, it is important to design the traces as a transmission line or 'stripline', to avoid reflections or ringing. In this case, the CMOS output needs to be matched to the trace impedance. Usually 'striplines' are designed for 50Ω impedance and CMOS outputs usually have lower than 50Ω impedance so matching can be achieved by adding a resistor in series with the CMOS output pin to the 'stripline' trace.

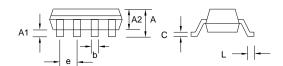


PACKAGE DRAWINGS (GREEN PACKAGE COMPLIANT)

SOP-8L

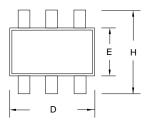
Symbol	Dimension in MM			
Symbol	Min.	Max.		
Α	1.35	1.75		
A1	0.10	0.25		
A2	1.25	1.50		
В	0.33	0.53		
С	0.19	0.27		
D	4.80	5.00		
Е	3.80	4.00		
Н	5.80	6.20		
L	0.40	0.89		
е	1.27 BSC			

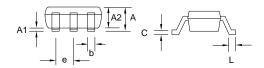




SOT23-6L

Cumbal	Dimension in MM			
Symbol	Min.	Max.		
Α	1.05	1.35		
A1	0.05	0.15		
A2	1.00	1.20		
В	0.30	0.50		
С	0.08	0.20		
D	2.80	3.00		
Е	1.50	1.70		
Н	2.60	3.0		
L	0.35	0.55		
е	e 0.95 BS			







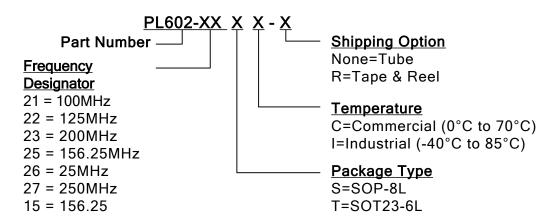
ORDERING INFORMATION (GREEN PACKAGE COMPLIANT)

For part ordering, please contact our Sales Department:

2180 Fortune Drive, San Jose, CA 95131, USA Tel: (408) 944-0800 Fax: (408) 474-1000

PART NUMBER

The order number for this device is a combination of the following: Part number, Package type and Operating temperature range



Part / Order Number	Marking	Package Option
PL602-2XSC	P602-2X	8-Pin SOP (Tube)
PL602-2XSC-R	SC LLLLL	8-Pin SOP (Tape and Reel)
PL602-1XTC-R	F1X LLL	6-Pin SOT-23 (Tape and Reel)
PL602-2XTC-R	F2X LLL	6-Pin SOT-23 (Tape and Reel)

Note: LLL / LLLLL designate Production Lot.

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9UMS9633BFILF 9VRS4450AKLF NB3N51132DTR2G 8N3Q001EG-0035CDI 932SQ426AKLF 950810CGLF 9DBV0531AKILF
9DBV0741AKILF 9FGV0641AKLF 9UMS9633BKLF 9VRS4420DKILF 9VRS4420DKLF 9VRS4420DKLFT CY25404ZXI226
CY25422SXI-004 5P49V5901B712NLGI NB3H5150-01MNTXG 6INT61041NDG PL602-20-K52TC PL613-51QC 8N3Q001FG-1114CDI
9FGV0641AKILF ZL30314GKG2 ZL30253LDG1 ZL30251LDG1 ZL30250LDG1 ZL30169LDG1 ZL30142GGG2 9UMS9633BKILFT
9FGV0631CKLFT 9FGV0631CKILF 5P49V5935B536LTGI PI6LC48P0101LIE DS1099U-ST+ MAX24305EXG+ PI6LC48H02-01LIE
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